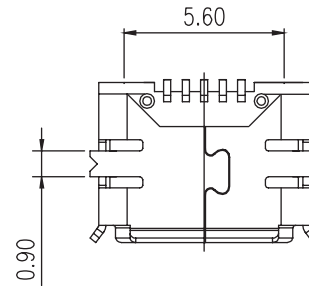
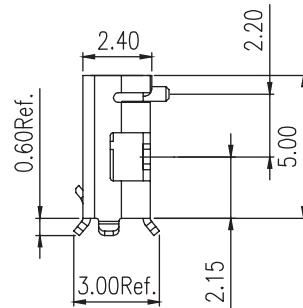
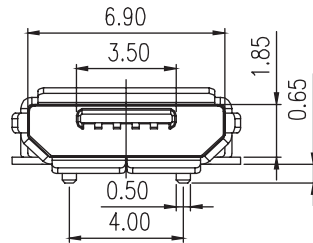
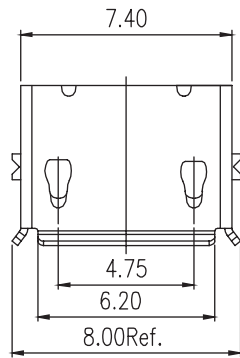
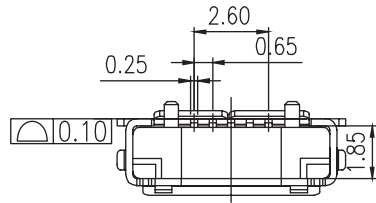


RoHS Compliant



SPECIFICATIONS

1. MATERIAL:

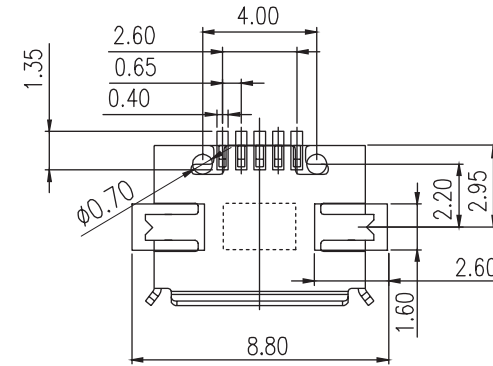
- 1.1 HOUSING: THERMOPLASTIC FLAMMABILITY RATING UL94V-0
- 1.2 CONTACT: COPPER ALLOY T=0.15mm
- 1.3 SHELL: COPPER ALLOY T=0.25mm

2. FINISH:

- 2.1 CONTACT:
 - 30 μ Min. PLATED ON CONTACT AREA
 - G/F PLATING ON SOLDER TAIL AREA
 - 50~80 μ "NICKEL UNDERPLATING OVERALL
- 2.2 SHELL:
 - 80~120 μ "MATTER TIN PLATING ALL
 - 50~80 μ " NICKEL UNDERPLATING OVERALL

3. SPECIFICATION:

- 3.1 CURRENT RATING: 2.0A MAX
- 3.2 VOLTAGE: 30 VAC
- 3.3 TEMPERATURE RANGE: -30 °C ~ 85 °C
- 3.4 CONTACT RESISTANCE: 30 MILLIONHM MAX
- 3.5 DIELECTRIC WITHSTANDING VOLTAGE: 200 VAC r.m.s
- 3.6 INSULATION RESISTNACE: 100 MEGOHMS MIN.



RECOMMENDED PCB LAYOUT(TOP VIEW)
GENERAL TOLERANCES:±0.05

6					PART NAME	MICRO USB JACK	*LVE* LAKE-VIEW ELECTRONICS CO., LTD.			
5					PART No.	MCU-5F-M2-2				
4					DESIGNER	YAOFEI WANG	VIEW		UNIT	mm
3					CHECKED BY	DELIANG LIU	VER	1.3	ANGLES	± 1.5°
2					APPROVED BY	David Chen	SHEET	1 OF 1	TOLERANCE	30≤L ± 0.30
1							DATE	'09.07.28		10≤L≤30 ± 0.25
NO.	DESCRIPTION	QTY	MATERIAL	PLATING						L≤10 ± 0.20